Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	BAS20DW	BAS21DW	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage	V_{RWM} V_R	150	200	V
RMS Reverse Voltage	$V_{R(RMS)}$	106	141	V
Forward Continuous Current (Note 8)	I_{FM}	400		mA
Average Rectified Output Current (Note 8)	I_O	200		mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0s	I_{FSM}	2.5 0.5		A
Repetitive Peak Forward Surge Current	I_{FRM}	625		mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	BAS20DW BAS21DW	$V_{(BR)R}$	200 250	— —	V	I_R = 100µA
Forward Voltage		V_F	—	1.0 1.25	V	I_F = 100mA I_F = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 7)		I_R	—	100 15	nA µA	T_J = +25°C T_J = +100°C
Total Capacitance		C_T	—	5.0	pF	V_R = 0, f = 1.0MHz
Reverse Recovery Time		t_{RR}	—	50	ns	I_F = I_R = 30mA, I_{RR} = 0.1 x I_R, R_L = 100Ω

Notes:
6. Part mounted on FR-4 substrate, 2 oz Cu pad layout board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
7. Short duration pulse test used to minimize self-heating effect.
8. Double Diode Loaded in Parallel. For Single Diode or Double Diode Loaded in Series, the continuous forward current should be reduced by half.

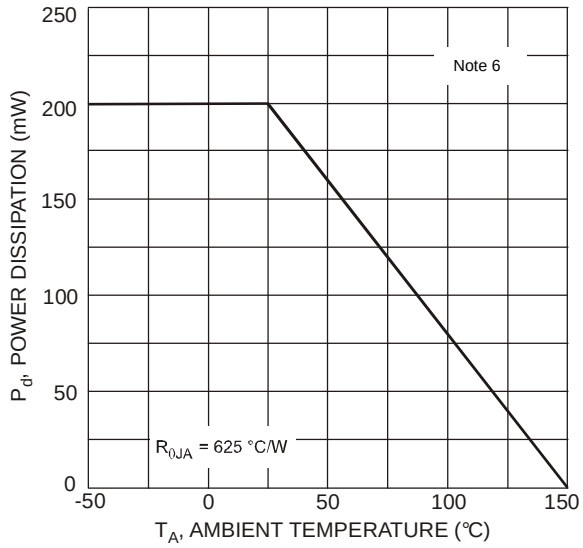

Fig. 1 Derating Curve - Total

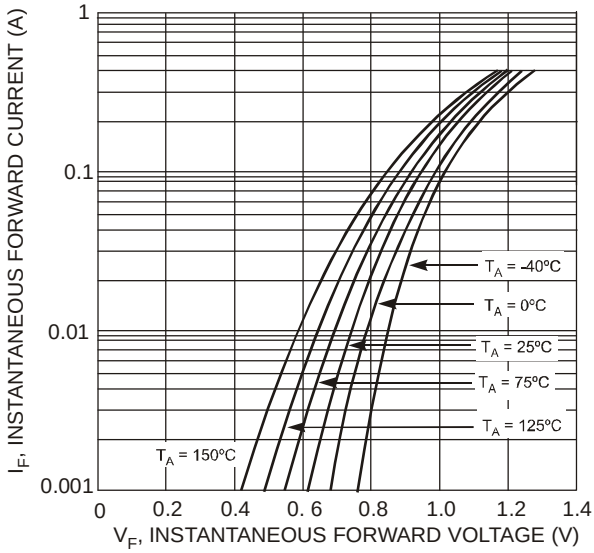

Fig. 2 Typical Forward Characteristics

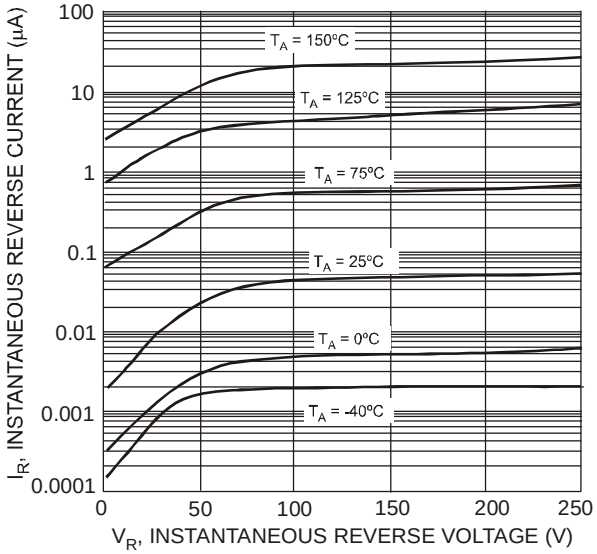

Fig. 3 Typical Reverse Characteristics

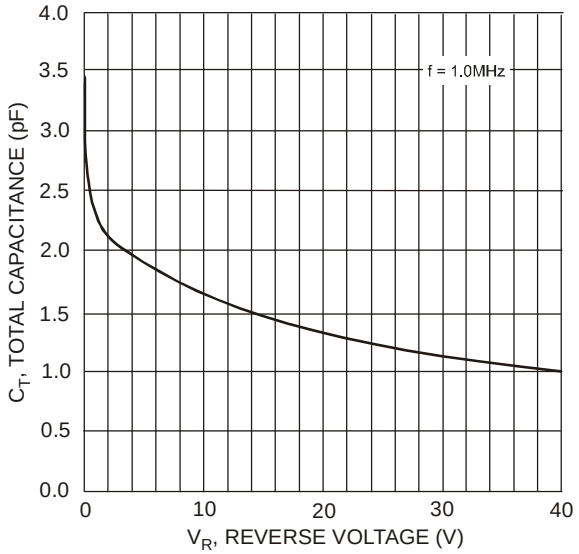

Fig. 4 Typical Capacitance vs. Reverse Voltage

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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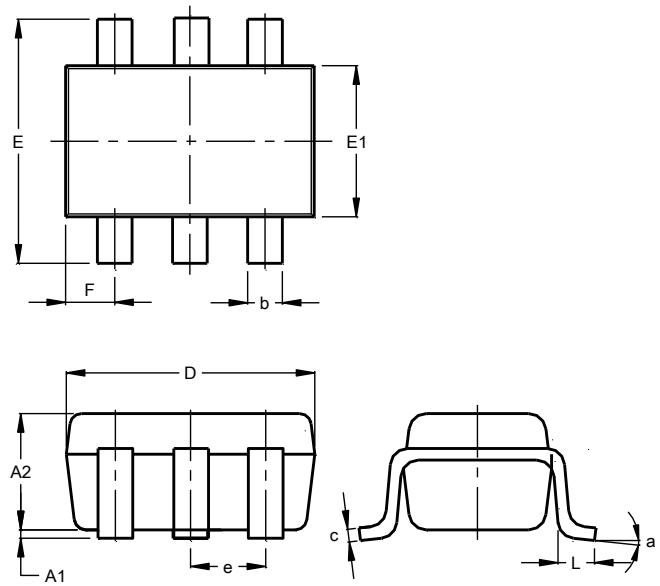

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Dim	**Min**	**Max**	**Typ**
A1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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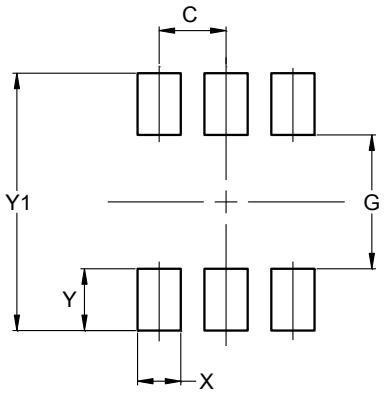

Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

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